Cus Cha	ification Number: 20200 Datasheet for AMC1311 tomer Contact: PCN Manage nge Type: Assembly Site Assembly Process	and				ot:	e 29, 2020 Quality Ser	vices
Cha	nge Type: Assembly Site		<u></u>	D	ep	ot:	Quality Ser	vices
Cha	nge Type: Assembly Site	<del>] [  </del>			_	,	Quality Sci	V1005
	Assembly Site							
		1 1 1	Design		1 [	Wafer	Bump Site	
			Data Sheet	F	1		Bump Mater	ial
	Assembly Materials		Part number change	F	il		Bump Proce	
	Mechanical Specification	lΗ	Test Site	F	11		Fab Site	
	Packing/Shipping/Labeling	lΠ	Test Process	F	Ħ		Fab Materia	S
	racking, simplify, labeling		1650116665	F	Ħ		Fab Process	
		N	otification Details			Traici	1 45 1 1 0 0 0 0 0	
Des	cription of Change:							
The The	as Instruments Incorporated is product datasheet(s) is being following change history provi	upda	ated as summarized below.	•	101	tificatio	า.	
7	INSTRUMENTS						AMC1311-	Q1
	NOTICIALIVIS		SB	8 <b>AS</b> 89	7B	-MARCH 20	18-REVISED MAY	2020
Ch	anges from Revision A (June 2018) to	Revis	sion B					Page
•	Changed automotive-specific Features b	ullets						1
•	Added Functional Safety-Capable bullets	s to Fe	eatures list.					1
•	Changed AMC1311B-Q1 offset drift from							
•								
•	Changed safety-related certifications details as per ISO standard							
•	Changed AMC1311B-Q1 values for TCV <sub>os</sub> , E <sub>g</sub> , and TCE <sub>g</sub> in <i>Device Comparison Table</i>							
•	Added ESD classification levels to ESD Ratings table							
•	Changed CLR and CPG values from 9 mm to 8.5 mm							
•	Changed Insulation Specifications table per ISO standard							
•	Changed Safety-Related Certification table per ISO standard							
•	Changed Safety Limiting Values description as per ISO standard							
•								
•	Changed E <sub>G</sub> parameter minimum value from –0.3% to –0.2% and maximum value from 0.3% to 0.2% for the  AMC1311B-Q1 in the <i>Electrical Characteristics</i> table							
•	Changed TCE <sub>G</sub> parameter minimum value 40 ppm/°C for the AMC1311B-Q1 in the							9
•	Changed Step Response of the AMC13	11B-G	91 figure					25
	Changed Stop Nouponed Or the 711110 To	775	, Tigal C					



_	anges from Revision A (June 2018) to Revisio			Page
•	Changed AMC1311B offset drift from $\pm 15 \mu\text{V/°C}$			
•	Changed AMC1311B gain error from ±0.3% (max) ppm/°C (max) to ±40 ppm/°C (max) in Features s			1
•	Changed safety-related certifications details as p	er ISO standard		1
•	Changed IEC 60950-1 and IEC60065 to IEC 623	368-1		1
•	Changed AMC1311B values for $TCV_{OS},E_{G},and$	TCE <sub>G</sub> in Device Comparison Table	9	3
•	Changed CLR and CPG values from 9 mm to 8.5 mm			
•	Changed Insulation Specifications table per ISO standard			
•	Changed Safety-Related Certification table per ISO standard			
•	Changed Safety Limiting Values description as per ISO standard			
•	Changed TCV <sub>OS</sub> parameter minimum value from $\mu$ V/°C for the AMC1311B in the <i>Electrical Character</i>	–15 μV/°C to –10 μV/°C and maxi cteristics table	mum value from 15 μV/°C to 1	0 8
•	Changed $E_G$ parameter minimum value from $-0.3$ AMC1311B in the <i>Electrical Characteristics</i> table			8
•	Changed TCE <sub>G</sub> parameter minimum value from -40 ppm/°C for the AMC1311B in the <i>Electrical Change</i>			
•	Changed Step Response of the AMC1311B figur	·e		24
	datasheet number will be changing. vice Family	Change From:	Change To:	
Device Fairing				
ΑM	C1311-Q1	SBAS897A	SBAS897B	
ΛМ	C1311	SBAS786A	SBAS786B	
<u> </u>				
	se changes may be reviewed at the	datasheet links provided		

http://www.ti.com/product/AMC1311

# **Reason for Change:**

To accurately reflect device characteristics.

# Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

## Changes to product identification resulting from this notification:

None.

#### **Product Affected:**

AMC1311BQDWVQ1	AMC1311BQDWVRQ1	AMC1311QDWVQ1	AMC1311QDWVRQ1
AMC1311BDWV	AMC1311BDWVR	AMC1311DWV	AMC1311DWVR

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